

DESCRIPTION

The ESD9DxxC is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its small size, it is suited for use in cellular phones, MP3 players, digital cameras and many other portable applications where board space is at a premium.

APPLICATIONS

- ✧ Cellular phones.
- ✧ Portable devices.
- ✧ Digital cameras.
- ✧ Power supplies.

FEATURES

- ✧ Small Body Outline Dimensions.
- ✧ Low Body Height.
- ✧ Peak Power up to 150 Watts @ 8 x 20 μ s Pulse.
- ✧ Low Leakage current.
- ✧ Response Time is Typically < 1 ns.

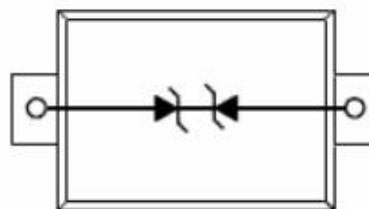
COMPLIES WITH THE FOLLOWING STANDARDS

- ✧ IEC61000-4-2.
- ✧ Level 4 15 kV (air discharge)
8 kV(contact discharge) .
- ✧ MIL STD 883E - Method 3015-7 Class 3
25 kV HBM (Human Body Model) .

SOD-923



PIN CONFIGURATION

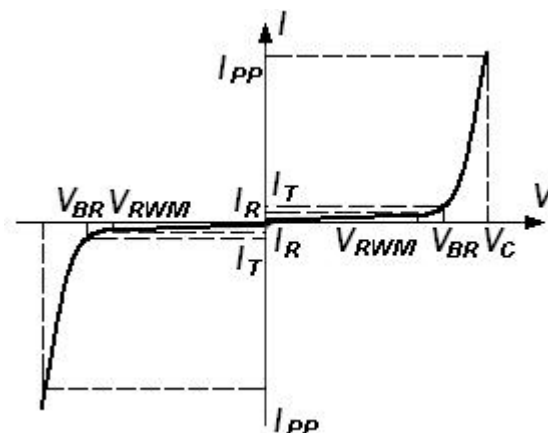


DEVICE CHARACTERISTICS

Absolute Ratings (Tamb=25°C)			
Symbol	Parameter	Value	Units
P _{pp}	Peak Pulse Power (t _p = 8/20μs)	150	W
T _L	Maximum lead temperature for soldering during 10s	260	°C
T _{stg}	Storage Temperature Range	-55 to +155	°C
T _{op}	Operating Temperature Range	-40 to +125	°C
T _j	Maximum junction temperature	150	°C
	IEC61000-4-2 (ESD)	±15	kV
	contact discharge	±8	
	IEC61000-4-4 (EFT)	40	A
	ESD Voltage	25	kV
	Per Human Body Model	400	V
	Per Machine Model		

ELECTRICAL PARAMETER

Symbol	Parameter
I _{pp}	Maximum Reverse Peak Pulse Current
V _c	Clamping Voltage @ I _{pp}
V _{RWM}	Working Peak Reverse Voltage
I _R	Maximum Reverse Leakage Current @ V _{RWM}
I _T	Test Current
V _{BR}	Breakdown Voltage @ I _T
I _T	Test Current
V _{BR}	Breakdown Voltage @ I _T



ELECTRICAL CHARACTERISTICS

Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified. VF = 0.9V at IF = 10mA)							
Part Numbers	VBR			IR	VRWM	IR	C
	Min.	Typ.	Max.				
	V	V	V				
ESD9D3V3C	5.1	6.0	6.8	1	3.3	1	20
ESD9D5C	5.6	6.7	7.8	1	5.0	1	10
ESD9D12C	13.3	14.5	15.7	1	12	1	9

*Surge current waveform per Figure 1.

1. VBR is measured with a pulse test current I_T at an ambient temperature of 25°C.

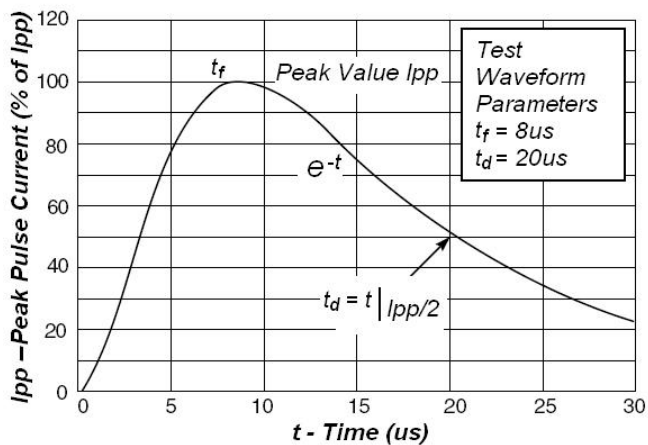
TYPICAL CHARACTERISTICS


Fig1. Pulse Waveform

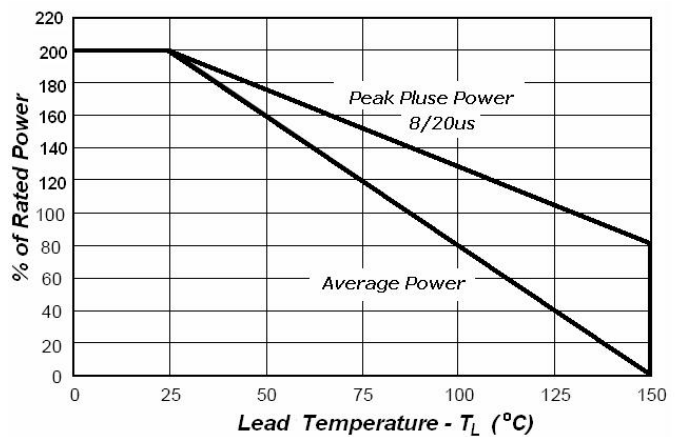
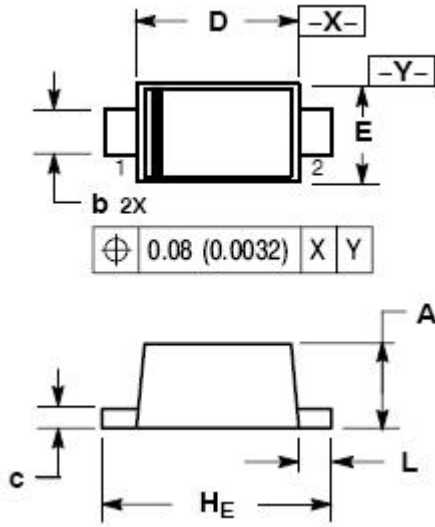
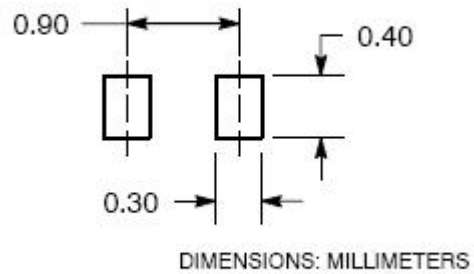


Fig2. Power Derating Curve

SOD-923 MECHANICAL DATA

SOLDERING FOOTPRINT*

SOD-923

Dim	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	0.36	0.40	0.43	0.014	0.016	0.017
b	0.15	0.20	0.25	0.006	0.008	0.010
c	0.07	0.12	0.17	0.003	0.005	0.007
D	0.75	0.80	0.85	0.030	0.031	0.033
E	0.55	0.60	0.65	0.022	0.024	0.026
HE	0.95	1.00	1.05	0.037	0.039	0.041
L	0.05	0.10	0.15	0.002	0.004	0.006

Website: <http://www.jksemi.com>

For additional information, please contact your local Sales Representative.

©Copyright 2016, jksemi